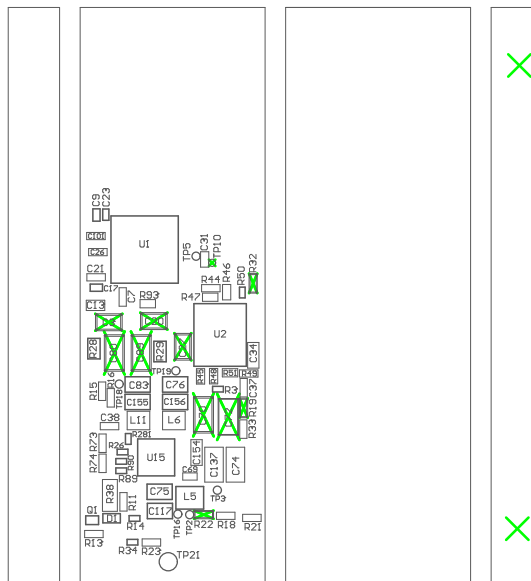


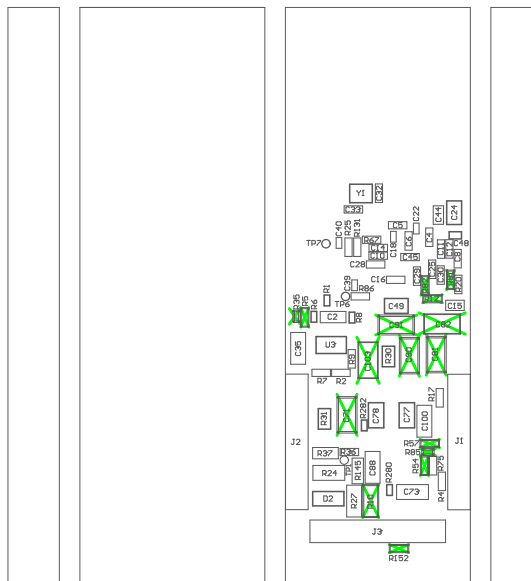
Z21 ■Install label in silkscreened box after final wash. Text shall be per the Label Table in the PDF schematic.  
 Z22 ■These assemblies are ESD sensitive, ESD precautions shall be observed.  
 Z23 ■These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.  
 Z24 ■These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.  
 Z25 ■INDICATION FOR COMPONENTS D\* ARE GIVEN AT THEIR CATHODE SIDE.

COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.  
 ASSEMBLY VARIANT: 001\_AWR



PCB VIEWED FROM TOP SIDE	BOARD #: TIDEP-01037	REV: A	SUN REV: Unknown revision
Assembly Layer Top	TID #: TIDEP-01037		
PLOT NAME = Top Assembly Drawing	GENERATED : 12/10/2024 3:27:30 PM		TEXAS INSTRUMENTS

COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.  
 ASSEMBLY VARIANT: 001\_AWR



PCB VIEWED FROM BOTTOM SIDE	BOARD #: TIDEP-01037	REV: A	SUN REV: Unknown revision
Assembly Bottom Layer	TID #: TIDEP-01037		
PLOT NAME = Bottom Assembly Drawing	GENERATED : 12/10/2024 3:27:30 PM		TEXAS INSTRUMENTS

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